# **74AUP1G97**

# **Low-power configurable multiple function gate**Rev. 8 — 15 August 2012 P

Product data sheet

#### **General description** 1.

The 74AUP1G97 provides configurable multiple functions. The output state is determined by eight patterns of 3-bit input. The user can choose the logic functions MUX, AND, OR, NAND, NOR, inverter and buffer. All inputs can be connected to V<sub>CC</sub> or GND.

This device ensures a very low static and dynamic power consumption across the entire V<sub>CC</sub> range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I<sub>OFF</sub>.

The I<sub>OFF</sub> circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The 74AUP1G97 has Schmitt trigger inputs making it capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

The inputs switch at different points for positive and negative-going signals. The difference between the positive voltage  $V_{T+}$  and the negative voltage  $V_{T-}$  is defined as the input hysteresis voltage V<sub>H</sub>.

#### **Features and benefits** 2.

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption;  $I_{CC} = 0.9 \mu A$  (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



## Low-power configurable multiple function gate

# 3. Ordering information

Table 1. Ordering information

| Type number | Package           |       |   |         |  |  |  |  |
|-------------|-------------------|-------|---|---------|--|--|--|--|
|             | Temperature range | Name  | Description   | Version |  |  |  |  |
| 74AUP1G97GW | –40 °C to +125 °C | SC-88 | plastic surface-mounted package; 6 leads  | SOT363  |  |  |  |  |
| 74AUP1G97GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm | SOT886  |  |  |  |  |
| 74AUP1G97GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1 $\times$ 0.5 mm    | SOT891  |  |  |  |  |
| 74AUP1G97GN | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm         | SOT1115 |  |  |  |  |
| 74AUP1G97GS | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body 1.0 $\times$ 1.0 $\times$ 0.35 mm       | SOT1202 |  |  |  |  |

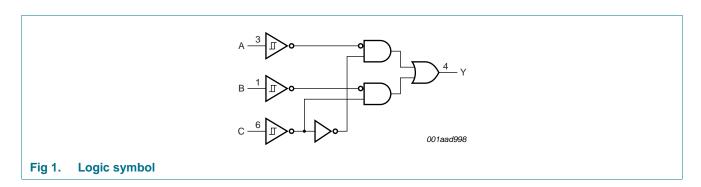
## 4. Marking

#### Table 2. Marking

| Type number | Marking code[1] |
|-------------|-----------------|
| 74AUP1G97GW | aV              |
| 74AUP1G97GM | aV              |
| 74AUP1G97GF | aV              |
| 74AUP1G97GN | aV              |
| 74AUP1G97GS | aV              |

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

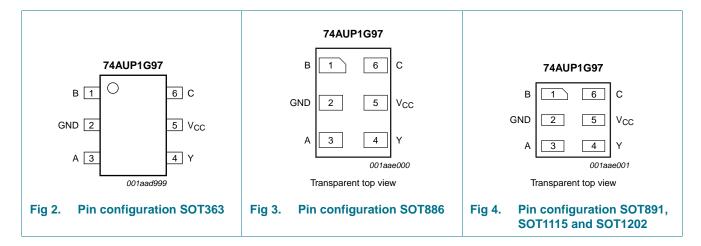
# 5. Functional diagram



Low-power configurable multiple function gate

# 6. Pinning information

#### 6.1 Pinning



#### 6.2 Pin description

Table 3. Pin description

| Symbol   | Pin | Description    |
|----------|-----|----------------|
| В        | 1   | data input     |
| GND      | 2   | ground (0 V)   |
| A        | 3   | data input     |
| Υ        | 4   | data output    |
| $V_{CC}$ | 5   | supply voltage |
| С        | 6   | data input     |

# 7. Functional description

Table 4. Function table[1]

| Input |   |   | Output |
|-------|---|---|--------|
| С     | В | Α | Υ      |
| L     | L | L | L      |
| L     | L | Н | L      |
| L     | Н | L | Н      |
| L     | Н | Н | Н      |
| Н     | L | L | L      |
| Н     | L | Н | Н      |
| Н     | Н | L | L      |
| Н     | Н | Н | Н      |

<sup>[1]</sup> H = HIGH voltage level;

L = LOW voltage level.

74AUP1G97

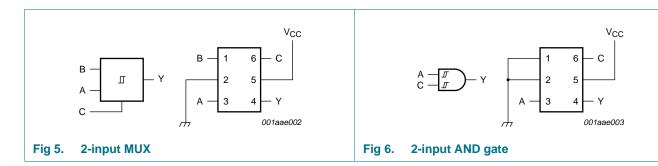
**74AUP1G97 NXP Semiconductors** 

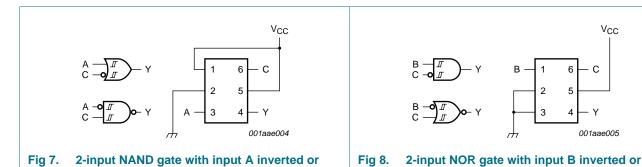
### Low-power configurable multiple function gate

## 7.1 Logic configurations

**Function selection table** Table 5.

| Logic function                       | Figure        |
|--------------------------------------|---------------|
| 2-input MUX                          | see Figure 5  |
| 2-input AND                          | see Figure 6  |
| 2-input OR with one input inverted   | see Figure 7  |
| 2-input NAND with one input inverted | see Figure 7  |
| 2-input AND with one input inverted  | see Figure 8  |
| 2-input NOR with one input inverted  | see Figure 8  |
| 2-input OR                           | see Figure 9  |
| Inverter                             | see Figure 10 |
| Buffer                               | see Figure 11 |





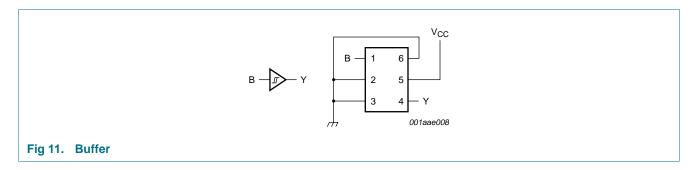
2-input OR gate with input C inverted

Vcc 001aae006 001aae007 Fig 9. 2-input OR gate Fig 10. Inverter

Vcc

2-input AND gate with input C inverted

#### Low-power configurable multiple function gate



## 8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min             | Max  | Unit |
|------------------|-------------------------|--|-----------------|------|------|
| $V_{CC}$         | supply voltage          |  | -0.5            | +4.6 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0 V   | <b>–50</b>      | -    | mA   |
| $V_{I}$          | input voltage           |  | <u>[1]</u> –0.5 | +4.6 | V    |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < 0 V   | <b>–50</b>      | -    | mA   |
| V <sub>O</sub>   | output voltage          | Active mode and Power-down mode                                      | <u>[1]</u> –0.5 | +4.6 | V    |
| Io               | output current          | $V_O = 0 V \text{ to } V_{CC}$                                       | -               | ±20  | mA   |
| I <sub>CC</sub>  | supply current          |  | -               | 50   | mA   |
| $I_{GND}$        | ground current          |  | <b>–50</b>      | -    | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65             | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$ | [2] -           | 250  | mW   |

<sup>[1]</sup> The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 9. Recommended operating conditions

Table 7. Recommended operating conditions

| Symbol    | Parameter           | Conditions                              | Min | Max      | Unit |
|-----------|---------------------|---|-----|----------|------|
| $V_{CC}$  | supply voltage      |   | 0.8 | 3.6      | V    |
| VI        | input voltage       |   | 0   | 3.6      | V    |
| Vo        | output voltage      | Active mode                             | 0   | $V_{CC}$ | V    |
|           |                     | Power-down mode; $V_{CC} = 0 \text{ V}$ | 0   | 3.6      | V    |
| $T_{amb}$ | ambient temperature |   | -40 | +125     | °C   |

<sup>[2]</sup> For SC-88 packages: above 87.5 °C the value of P<sub>tot</sub> derates linearly with 4.0 mW/K. For XSON6 packages: above 118 °C the value of P<sub>tot</sub> derates linearly with 7.8 mW/K.

## Low-power configurable multiple function gate

## 10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol               | Parameter                            | Conditions   | Min                   | Тур | Max                  | Unit         |
|----------------------|--------------------------------------|--|-----------------------|-----|----------------------|--------------|
| T <sub>amb</sub> = 2 | 5 °C                                 |  |                       |     |                      |              |
| V <sub>OH</sub>      | HIGH-level output voltage            | $V_I = V_{T+}$ or $V_{T-}$   |                       |     |                      |              |
|                      |                                      | $I_{O} = -20 \mu A$ ; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$                                 | V <sub>CC</sub> - 0.1 | -   | -                    | V            |
|                      |                                      | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$  | 0.75V <sub>CC</sub>   | -   | -                    | V            |
|                      |                                      | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$  | 1.11                  | -   | -                    | V            |
|                      |                                      | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$   | 1.32                  | -   | -                    | V            |
|                      |                                      | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$  | 2.05                  | -   | -                    | V            |
|                      |                                      | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$  | 1.9                   | -   | -                    | V            |
|                      |                                      | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$  | 2.72                  | -   | -                    | V            |
|                      |                                      | $I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$  | 2.6                   | -   | -                    | V            |
| V <sub>OL</sub>      | LOW-level output voltage             | $V_I = V_{T+}$ or $V_{T-}$   |                       |     |                      |              |
|                      |                                      | $I_O = 20 \mu A$ ; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$                                    | -                     | -   | 0.1                  | V            |
|                      |                                      | I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V   | -                     | -   | 0.3V <sub>CC</sub>   | V            |
|                      |                                      | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$   | -                     | -   | 0.31                 | V            |
|                      |                                      | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$  | -                     | -   | 0.31                 | V            |
|                      |                                      | $I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$   | -                     | -   | 0.31                 | V            |
|                      |                                      | $I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$   | -                     | -   | 0.44                 | V            |
|                      |                                      | $I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$   | -                     | -   | 0.31                 | V            |
|                      |                                      | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$   | -                     | -   | 0.44                 | V            |
| l <sub>l</sub>       | input leakage current                | $V_{I} = GND \text{ to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$                  | -                     | -   | ±0.1                 | μΑ           |
| l <sub>OFF</sub>     | power-off leakage current            | $V_{I}$ or $V_{O} = 0 \text{ V}$ to 3.6 V; $V_{CC} = 0 \text{ V}$                                | -                     | -   | ±0.2                 | μΑ           |
| $\Delta I_{OFF}$     | additional power-off leakage current | $V_1$ or $V_0 = 0$ V to 3.6 V;<br>$V_{CC} = 0$ V to 0.2 V  | -                     | -   | ±0.2                 | μА           |
| Icc                  | supply current                       | $V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$<br>$V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ | -                     | -   | 0.5                  | μА           |
| Δl <sub>CC</sub>     | additional supply current            | $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$<br>$V_{CC} = 3.3 \text{ V}$                   | [1] -                 | -   | 40                   | μА           |
| Cı                   | input capacitance                    | $V_{CC} = 0 \text{ V to } 3.6 \text{ V}; V_I = \text{GND or } V_{CC}$                            | -                     | 1.1 | -                    | pF           |
| Co                   | output capacitance                   | $V_O = GND$ ; $V_{CC} = 0 V$   | -                     | 1.7 | -                    | pF           |
|                      | 40 °C to +85 °C                      |  |                       |     |                      |              |
| V <sub>OH</sub>      | HIGH-level output voltage            | $V_I = V_{T+}$ or $V_{T-}$   |                       |     |                      |              |
|                      |                                      | $I_{O} = -20 \mu A$ ; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$                                 | V <sub>CC</sub> - 0.1 | -   | -                    | V            |
|                      |                                      | $I_{O} = -1.1 \text{ mA}$ ; $V_{CC} = 1.1 \text{ V}$   | 0.7V <sub>CC</sub>    | -   | -                    | V            |
|                      |                                      | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$  | 1.03                  | -   | -                    | V            |
|                      |                                      | $I_{\rm O} = -1.9$ mA; $V_{\rm CC} = 1.65$ V   | 1.30                  | -   | -                    | V            |
|                      |                                      | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$  | 1.97                  | -   | -                    | V            |
|                      |                                      | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$  | 1.85                  | -   | -                    | V            |
|                      |                                      | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$  | 2.67                  | -   | -                    | V            |
|                      |                                      | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$  | 2.55                  | -   | -                    | V            |
| 4AUP1G97             |                                      | All information provided in this document is subject to legal discla                             | imers.                |     | © NXP B.V. 2012. All | rights reser |

## Low-power configurable multiple function gate

**Table 8. Static characteristics** ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol               | Parameter                            | Conditions   | Min                    | Тур | Max                 | Unit |
|----------------------|--------------------------------------|--|------------------------|-----|---------------------|------|
| V <sub>OL</sub>      | LOW-level output voltage             | $V_I = V_{T+}$ or $V_{T-}$   |                        |     |                     |      |
|                      |                                      | $I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 0.8 $V$ to 3.6 $V$                                | -                      | -   | 0.1                 | V    |
|                      |                                      | I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V                                   | -                      | -   | $0.3V_{CC}$         | V    |
|                      |                                      | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$                                     | -                      | -   | 0.37                | V    |
|                      |                                      | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$                                    | -                      | -   | 0.35                | V    |
|                      |                                      | $I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$                                     | -                      | -   | 0.33                | V    |
|                      |                                      | $I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$                                     | -                      | -   | 0.45                | V    |
|                      |                                      | $I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$                                     | -                      | -   | 0.33                | V    |
|                      |                                      | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$                                     | -                      | -   | 0.45                | V    |
| l <sub>l</sub>       | input leakage current                | $V_I$ = GND to 3.6 V; $V_{CC}$ = 0 V to 3.6 V                                      | -                      | -   | ±0.5                | μΑ   |
| l <sub>OFF</sub>     | power-off leakage current            | $V_{I}$ or $V_{O} = 0 \text{ V}$ to 3.6 V; $V_{CC} = 0 \text{ V}$                  | -                      | -   | ±0.5                | μΑ   |
| Δl <sub>OFF</sub>    | additional power-off leakage current | $V_1$ or $V_0 = 0$ V to 3.6 V;<br>$V_{CC} = 0$ V to 0.2 V                          | -                      | -   | ±0.6                | μΑ   |
| I <sub>CC</sub>      | supply current                       | $V_I$ = GND or $V_{CC}$ ; $I_O$ = 0 A; $V_{CC}$ = 0.8 V to 3.6 V                   | -                      | -   | 0.9                 | μΑ   |
| Δl <sub>CC</sub>     | additional supply current            | $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$<br>$V_{CC} = 3.3 \text{ V}$ | [1] -                  | -   | 50                  | μΑ   |
| T <sub>amb</sub> = - | 40 °C to +125 °C                     |  |                        |     |                     |      |
| $V_{OH}$             | HIGH-level output voltage            | $V_I = V_{T+}$ or $V_{T-}$   |                        |     |                     |      |
|                      |                                      | $I_{O} = -20 \mu A$ ; $V_{CC} = 0.8 \text{ V}$ to 3.6 V                            | V <sub>CC</sub> – 0.11 | -   | -                   | V    |
|                      |                                      | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$                                  | 0.6V <sub>CC</sub>     | -   | -                   | V    |
|                      |                                      | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$                                  | 0.93                   | -   | -                   | V    |
|                      |                                      | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$                                 | 1.17                   | -   | -                   | V    |
|                      |                                      | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$                                  | 1.77                   | -   | -                   | V    |
|                      |                                      | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$                                  | 1.67                   | -   | -                   | V    |
|                      |                                      | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$                                  | 2.40                   | -   | -                   | V    |
|                      |                                      | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$                                  | 2.30                   | -   | -                   | V    |
| V <sub>OL</sub>      | LOW-level output voltage             | $V_I = V_{T+}$ or $V_{T-}$   |                        |     |                     |      |
|                      |                                      | $I_O = 20 \mu A$ ; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$                      | -                      | -   | 0.11                | V    |
|                      |                                      | $I_O = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$                                     | -                      | -   | 0.33V <sub>CC</sub> | V    |
|                      |                                      | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$                                     | -                      | -   | 0.41                | V    |
|                      |                                      | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$                                    | -                      | -   | 0.39                | V    |
|                      |                                      | $I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$                                     | -                      | -   | 0.36                | V    |
|                      |                                      | $I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$                                     | -                      | -   | 0.50                | V    |
|                      |                                      | I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V                                   | -                      | -   | 0.36                | V    |
|                      |                                      | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V                                   | -                      | -   | 0.50                | V    |
| <br>  <sub> </sub>   | input leakage current                | $V_{I} = GND \text{ to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$    | -                      | -   | ±0.75               | μΑ   |
| I <sub>OFF</sub>     | power-off leakage current            | $V_{I}$ or $V_{O} = 0 \text{ V}$ to 3.6 V; $V_{CC} = 0 \text{ V}$                  |                        |     | ±0.75               | μA   |

#### Low-power configurable multiple function gate

 Table 8.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                            | Conditions   | Min          | Тур | Max   | Unit |
|------------------|--------------------------------------|--|--------------|-----|-------|------|
| $\Delta I_{OFF}$ | additional power-off leakage current | $V_1$ or $V_0 = 0$ V to 3.6 V;<br>$V_{CC} = 0$ V to 0.2 V                      | -            | -   | ±0.75 | μΑ   |
| I <sub>CC</sub>  | supply current                       | $V_I$ = GND or $V_{CC}$ ; $I_O$ = 0 A; $V_{CC}$ = 0.8 V to 3.6 V               | -            | -   | 1.4   | μΑ   |
| $\Delta I_{CC}$  | additional supply current            | $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$<br>$V_{CC} = 3.3 \text{ V}$ | <u>[1]</u> - | -   | 75    | μΑ   |

<sup>[1]</sup> One input at  $V_{CC}$  – 0.6 V, other input at  $V_{CC}$  or GND.

# 11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 13.

| Parameter         | Conditions                                   |   | 25 °C   |                   |   | -40 °C to +125 °C  |   |  | Unit   |
|-------------------|--|---|---|-------------------|---|--------------------|---|--|--|
|                   |  |   | Min   | Typ[1]            | Max   | Min                | Max<br>(85 °C)  | Max<br>(125 °C)                        |  |
| Ė                 |  |   |   | '                 |   | '                  | '   | 1                                      |  |
| propagation delay | A, B, C to Y; see Figure 12                  | [2]   |   |                   |   |                    |   |  |  |
|                   | $V_{CC} = 0.8 \text{ V}$                     |   | -   | 23.0              | -   | -                  | -   | -                                      | ns   |
|                   | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$   |   | 2.8   | 6.6               | 12.6  | 2.5                | 13.0  | 13.2                                   | ns   |
|                   | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$   |   | 2.3   | 4.7               | 7.6   | 2.5                | 8.2   | 8.6                                    | ns   |
|                   | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ |   | 2.2   | 3.9               | 6.2   | 2.0                | 6.8   | 7.2                                    | ns   |
|                   | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   |   | 2.0   | 3.2               | 4.5   | 1.7                | 5.1   | 5.3                                    | ns   |
|                   | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$   |   | 1.9   | 2.9               | 3.9   | 1.5                | 4.1   | 4.3                                    | ns   |
| o <b>F</b>        |  |   |   |                   |   |                    |   |  |  |
| propagation delay | A, B, C to Y; see Figure 12                  | [2]   |   |                   |   |                    |   |  |  |
|                   | $V_{CC} = 0.8 \text{ V}$                     |   | -   | 26.6              | -   | -                  | -   | -                                      | ns   |
|                   | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$   |   | 3.2   | 7.4               | 14.3  | 2.9                | 14.9  | 15.2                                   | ns   |
|                   | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$   |   | 2.6   | 5.3               | 8.7   | 2.8                | 9.4   | 9.8                                    | ns   |
|                   | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ |   | 2.5   | 4.5               | 7.0   | 2.3                | 7.8   | 8.2                                    | ns   |
|                   | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   |   | 2.4   | 3.7               | 5.2   | 2.1                | 5.9   | 6.1                                    | ns   |
|                   | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$   |   | 2.3   | 3.4               | 4.6   | 1.9                | 4.9   | 5.1                                    | ns   |
| o <b>F</b>        |  |   |   |                   |   |                    |   |  |  |
| propagation delay | A, B, C to Y; see Figure 12                  | [2]   |   |                   |   |                    |   |  |  |
|                   | $V_{CC} = 0.8 \text{ V}$                     |   | -   | 30.1              | -   | -                  | -   | -                                      | ns   |
|                   | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$   |   | 3.6   | 8.2               | 16.0  | 3.2                | 16.7  | 17.0                                   | ns   |
|                   | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$   |   | 2.9   | 5.9               | 9.6   | 3.1                | 10.4  | 10.9                                   | ns   |
|                   | $V_{CC}$ = 1.65 V to 1.95 V                  |   | 2.8   | 5.0               | 7.8   | 2.5                | 8.7   | 9.1                                    | ns   |
|                   | $V_{CC}$ = 2.3 V to 2.7 V                    |   | 2.7   | 4.2               | 5.8   | 2.4                | 6.5   | 6.9                                    | ns   |
|                   | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$   |   | 2.5   | 3.8               | 5.1   | 2.2                | 5.5   | 5.7                                    | ns   |
|                   | propagation delay  F  propagation delay      | propagation delay A, B, C to Y; see Figure 12 $V_{CC} = 0.8 \text{ V}$ $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ Propagation delay A, B, C to Y; see Figure 12 $V_{CC} = 0.8 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ Propagation delay A, B, C to Y; see Figure 12 $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | propagation delay A, B, C to Y; see Figure 12 $V_{CC} = 0.8 \text{ V}$ $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ Propagation delay A, B, C to Y; see Figure 12 $V_{CC} = 0.8 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ Propagation delay A, B, C to Y; see Figure 12 $V_{CC} = 0.8 \text{ V}$ $V_{CC} = 0.8 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.3 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.3 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.3 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | propagation delay | Propagation delay Propagation | Min   Typ[1]   Max | Propagation delay Propagation | Min   Typ[1]   Max   Min   Max (85 °C) | Propagation delay   A, B, C to Y; see Figure 12   22 |

## Low-power configurable multiple function gate

 Table 9.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 13.

| Symbol              | Parameter           | Conditions   |     | 25 °C  |      |     | -40 °C to +125 °C |                 |    |  |
|---------------------|---------------------|--|-----|--------|------|-----|-------------------|-----------------|----|--|
|                     |                     |  | Min | Typ[1] | Max  | Min | Max<br>(85 °C)    | Max<br>(125 °C) |    |  |
| C <sub>L</sub> = 30 | ρF                  |  |     |        | '    |     | '                 | •               |    |  |
| t <sub>pd</sub>     | propagation delay   | A, B, C to Y; see Figure 12                        | [2] |        |      |     |                   |                 |    |  |
|                     |                     | $V_{CC} = 0.8 \text{ V}$                           | -   | 38.3   | -    | -   | -                 | -               | ns |  |
|                     |                     | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$         | 4.6 | 10.5   | 20.9 | 4.0 | 21.8              | 22.2            | ns |  |
|                     |                     | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$         | 3.7 | 7.4    | 12.2 | 3.8 | 13.3              | 14.0            | ns |  |
|                     |                     | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$       | 3.5 | 6.3    | 9.9  | 3.2 | 11.1              | 11.8            | ns |  |
|                     |                     | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$         | 3.4 | 5.3    | 7.4  | 3.1 | 8.3               | 8.8             | ns |  |
|                     |                     | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$         | 3.2 | 4.9    | 6.6  | 2.8 | 7.0               | 7.4             | ns |  |
| $C_L = 5 p$         | F, 10 pF, 15 pF and | 30 pF  |     |        |      |     |                   |                 |    |  |
| $C_{PD}$            | power dissipation   | $f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$ | [3] |        |      |     |                   |                 |    |  |
|                     | capacitance         | $V_{CC} = 0.8 \text{ V}$                           | -   | 2.6    | -    | -   | -                 | -               | pF |  |
|                     |                     | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$         | -   | 2.8    | -    | -   | -                 | -               | pF |  |
|                     |                     | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$         | -   | 2.9    | -    | -   | -                 | -               | pF |  |
|                     |                     | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$       | -   | 3.1    | -    | -   | -                 | -               | pF |  |
|                     |                     | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$         | -   | 3.7    | -    | -   | -                 | -               | pF |  |
|                     |                     | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$         | -   | 4.3    | -    | -   | -                 | -               | pF |  |

<sup>[1]</sup> All typical values are measured at nominal V<sub>CC</sub>.

$$P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o) \text{ where:}$$

 $f_i$  = input frequency in MHz;

 $f_o$  = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

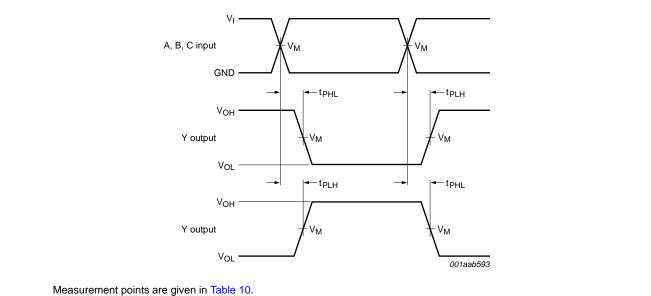
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

<sup>[2]</sup>  $\;\;t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ 

<sup>[3]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

#### Low-power configurable multiple function gate

## 12. Waveforms



wedstrement points are given in table to.

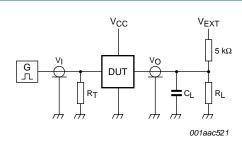
 $\ensuremath{V_{OL}}$  and  $\ensuremath{V_{OH}}$  are typical output voltage drop that occur with the output load.

Fig 12. Input A, B and C to output Y propagation delay times

Table 10. Measurement points

| Supply voltage  | Output             | Input              |                 |             |
|-----------------|--------------------|--------------------|-----------------|-------------|
| V <sub>CC</sub> | V <sub>M</sub>     | V <sub>M</sub>     | V <sub>I</sub>  | $t_r = t_f$ |
| 0.8 V to 3.6 V  | 0.5V <sub>CC</sub> | 0.5V <sub>CC</sub> | V <sub>CC</sub> | ≤ 3.0 ns    |

#### Low-power configurable multiple function gate



Test data is given in Table 11.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

V<sub>EXT</sub> = External voltage for measuring switching times.

Fig 13. Test circuit for measuring switching times

Table 11. Test data

| Supply voltage  | Load                         |                              | V <sub>EXT</sub>                    |                                     |                                     |
|-----------------|------------------------------|------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|
| V <sub>CC</sub> | C <sub>L</sub>               | R <sub>L</sub> [1]           | t <sub>PLH</sub> , t <sub>PHL</sub> | t <sub>PZH</sub> , t <sub>PHZ</sub> | t <sub>PZL</sub> , t <sub>PLZ</sub> |
| 0.8 V to 3.6 V  | 5 pF, 10 pF, 15 pF and 30 pF | 5 k $\Omega$ or 1 M $\Omega$ | open                                | GND                                 | 2V <sub>CC</sub>                    |

<sup>[1]</sup> For measuring enable and disable times  $R_L$  = 5 k $\Omega$ , for measuring propagation delays, setup and hold times and pulse width  $R_L$  = 1 M $\Omega$ .

#### 13. Transfer characteristics

Table 12. Transfer characteristics

Voltages are referenced to GND (ground = 0 V; for test circuit see <u>Figure 13</u>.

| Symbol  | Parameter                      | Conditions                  |      | 25 °C |      | -40 °C to +125 °C |                 |      | Unit |
|---|--------------------------------|-----------------------------|------|-------|------|-------------------|-----------------|------|------|
|   |                                | Min                         | Тур  | Max   | Min  | Max<br>(85 °C)    | Max<br>(125 °C) |      |      |
| $V_{T+}$  | V <sub>T+</sub> positive-going | see Figure 14 and Figure 15 |      |       |      |                   |                 |      |      |
|   | threshold voltage              | $V_{CC} = 0.8 \text{ V}$    | 0.30 | -     | 0.60 | 0.30              | 0.60            | 0.62 | V    |
|   |                                | V <sub>CC</sub> = 1.1 V     | 0.53 | -     | 0.90 | 0.53              | 0.90            | 0.92 | V    |
|   |                                | V <sub>CC</sub> = 1.4 V     | 0.74 | -     | 1.11 | 0.74              | 1.11            | 1.13 | V    |
|   |                                | V <sub>CC</sub> = 1.65 V    | 0.91 | -     | 1.29 | 0.91              | 1.29            | 1.31 | V    |
|   | V <sub>CC</sub> = 2.3 V        | 1.37                        | -    | 1.77  | 1.37 | 1.77              | 1.80            | V    |      |
|   |                                | V <sub>CC</sub> = 3.0 V     | 1.88 | -     | 2.29 | 1.88              | 2.29            | 2.32 | V    |
| V <sub>T</sub> - negative-going threshold voltage |                                | see Figure 14 and Figure 15 |      |       |      |                   |                 |      |      |
|   | threshold voltage              | V <sub>CC</sub> = 0.8 V     | 0.10 | -     | 0.60 | 0.10              | 0.60            | 0.60 | V    |
|   |                                | V <sub>CC</sub> = 1.1 V     | 0.26 | -     | 0.65 | 0.26              | 0.65            | 0.65 | V    |
|   |                                | V <sub>CC</sub> = 1.4 V     | 0.39 | -     | 0.75 | 0.39              | 0.75            | 0.75 | V    |
|   |                                | V <sub>CC</sub> = 1.65 V    | 0.47 | -     | 0.84 | 0.47              | 0.84            | 0.84 | V    |
|   |                                | V <sub>CC</sub> = 2.3 V     | 0.69 | -     | 1.04 | 0.69              | 1.04            | 1.04 | V    |
|   |                                | V <sub>CC</sub> = 3.0 V     | 0.88 | -     | 1.24 | 0.88              | 1.24            | 1.24 | V    |

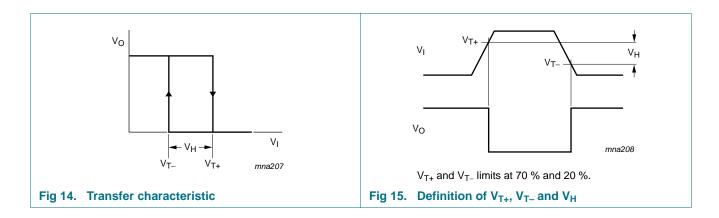
#### Low-power configurable multiple function gate

 Table 12.
 Transfer characteristics ...continued

Voltages are referenced to GND (ground = 0 V; for test circuit see Figure 13.

| Symbol                            | Parameter                | Conditions  |      | 25 °C |      | -40 °C to +125 °C |                |                 | Unit |
|-----------------------------------|--------------------------|---|------|-------|------|-------------------|----------------|-----------------|------|
|                                   |                          |   | Min  | Тур   | Max  | Min               | Max<br>(85 °C) | Max<br>(125 °C) |      |
| V <sub>H</sub> hysteresis voltage |                          | (V <sub>T+</sub> – V <sub>T-</sub> ); see <u>Figure 14</u> ,<br><u>Figure 15</u> , <u>Figure 16</u> and<br><u>Figure 17</u> |      |       |      |                   |                |                 |      |
|                                   | V <sub>CC</sub> = 0.8 V  | 0.07  | -    | 0.50  | 0.07 | 0.50              | 0.50           | V               |      |
|                                   | V <sub>CC</sub> = 1.1 V  | 0.08  | -    | 0.46  | 0.08 | 0.46              | 0.46           | V               |      |
|                                   | V <sub>CC</sub> = 1.4 V  | 0.18  | -    | 0.56  | 0.18 | 0.56              | 0.56           | V               |      |
|                                   | V <sub>CC</sub> = 1.65 V | 0.27  | -    | 0.66  | 0.27 | 0.66              | 0.66           | V               |      |
|                                   | V <sub>CC</sub> = 2.3 V  | 0.53  | -    | 0.92  | 0.53 | 0.92              | 0.92           | V               |      |
|                                   |                          | V <sub>CC</sub> = 3.0 V   | 0.79 | -     | 1.31 | 0.79              | 1.31           | 1.31            | V    |

## 14. Waveforms transfer characteristics



## Low-power configurable multiple function gate

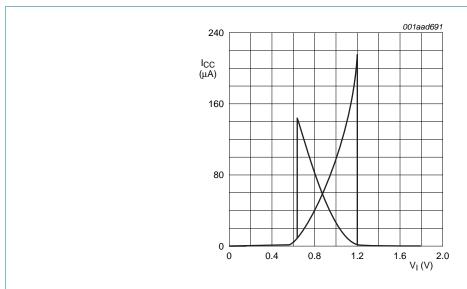


Fig 16. Typical transfer characteristics;  $V_{CC} = 1.8 \text{ V}$ 

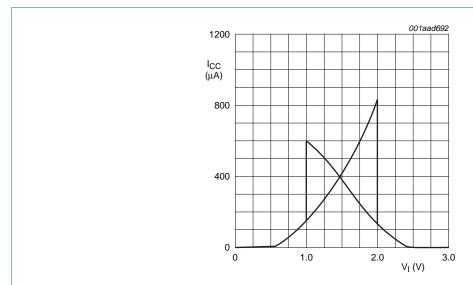


Fig 17. Typical transfer characteristics;  $V_{CC} = 3.0 \text{ V}$ 

#### Low-power configurable multiple function gate

## 15. Package outline

#### Plastic surface-mounted package; 6 leads

**SOT363** 

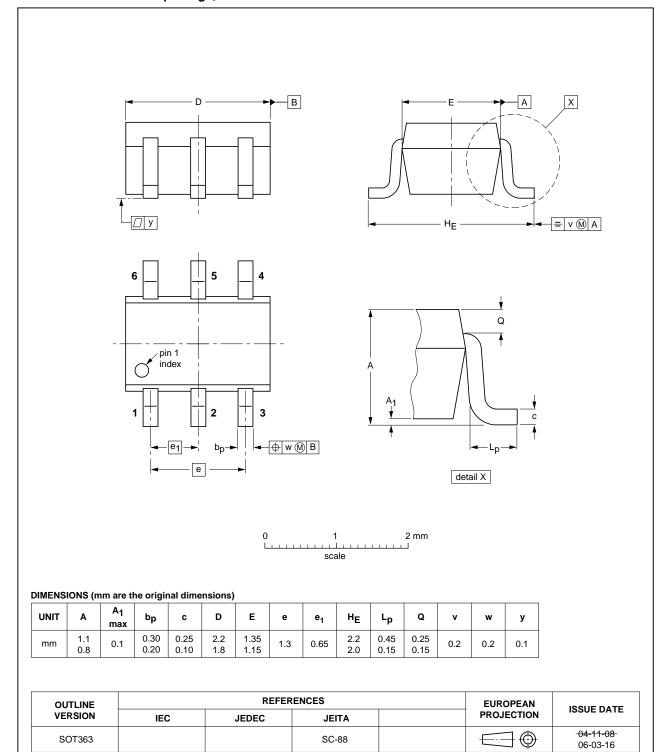


Fig 18. Package outline SOT363 (SC-88)

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#### Low-power configurable multiple function gate

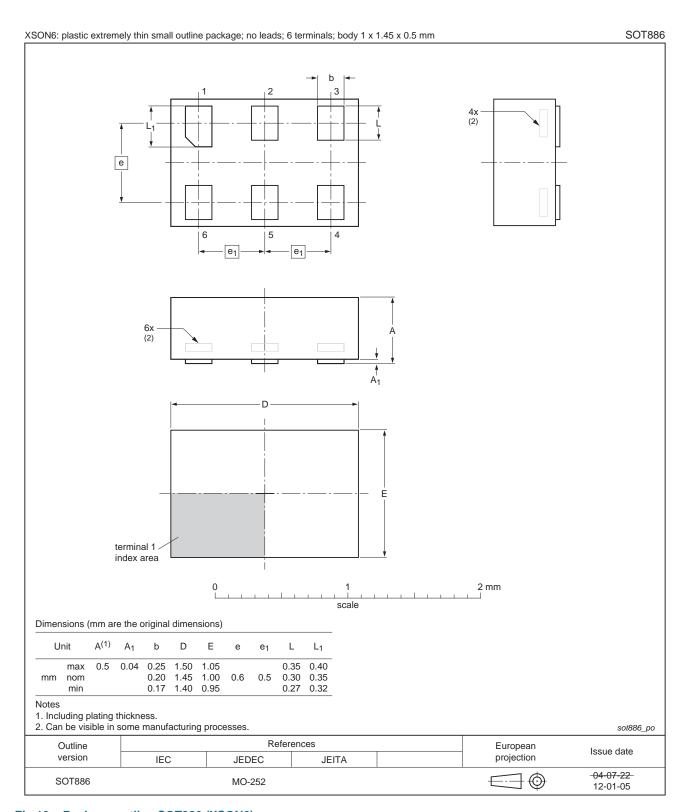


Fig 19. Package outline SOT886 (XSON6)

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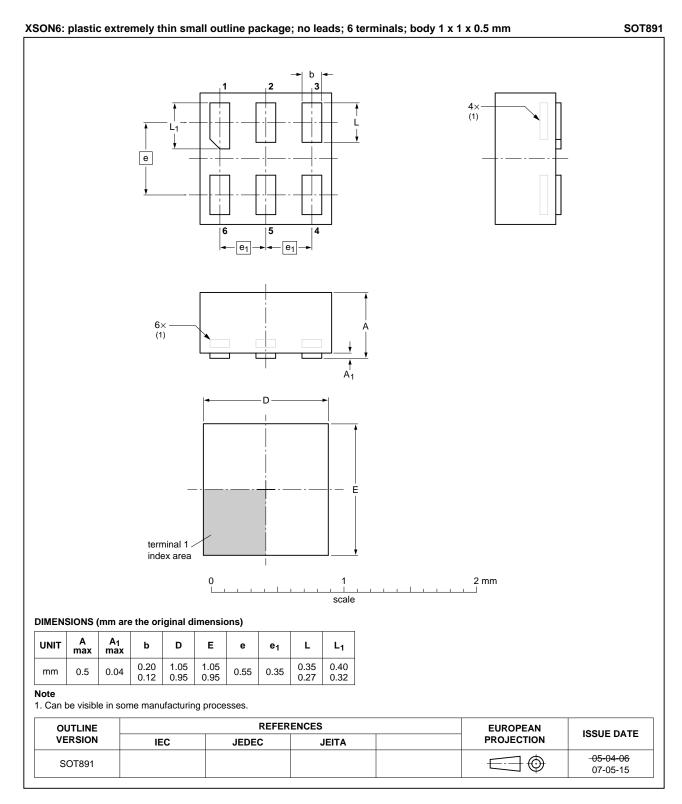


Fig 20. Package outline SOT891 (XSON6)

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#### Low-power configurable multiple function gate

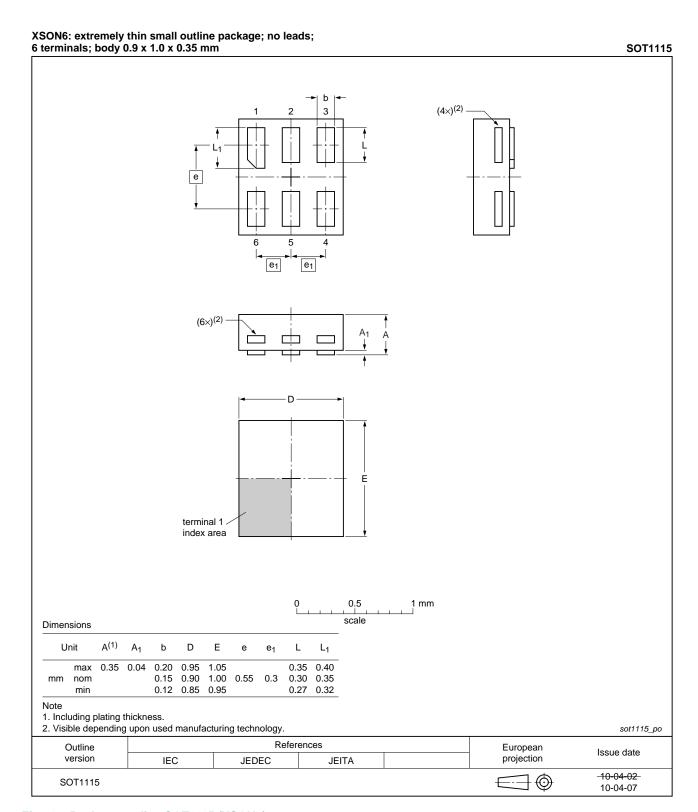


Fig 21. Package outline SOT1115 (XSON6)

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#### Low-power configurable multiple function gate

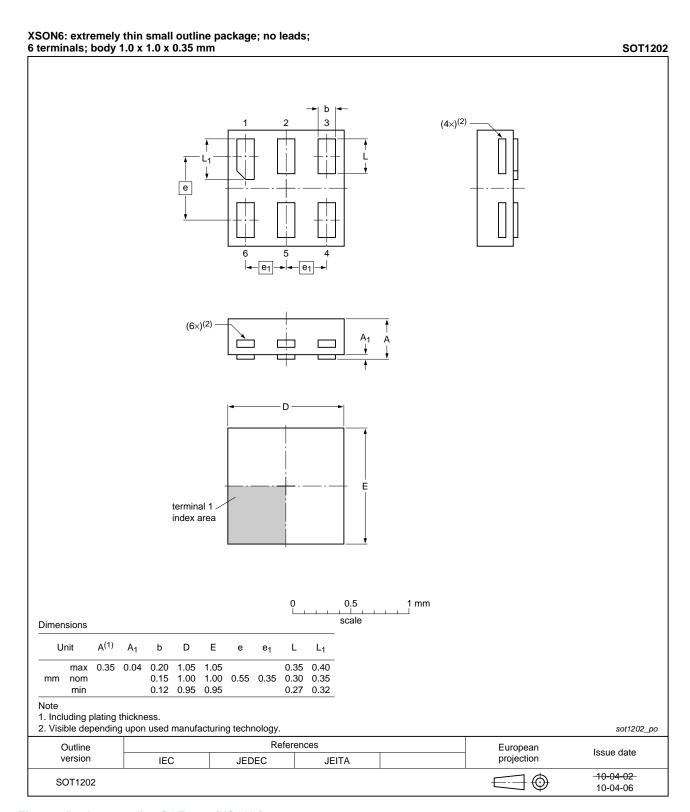


Fig 22. Package outline SOT1202 (XSON6)

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## Low-power configurable multiple function gate

## 16. Abbreviations

#### Table 13. Abbreviations

| Acronym | Description             |
|---------|-------------------------|
| CDM     | Charged Device Model    |
| DUT     | Device Under Test       |
| ESD     | ElectroStatic Discharge |
| НВМ     | Human Body Model        |
| MM      | Machine Model           |

# 17. Revision history

#### Table 14. Revision history

| Document ID    | Release date                      | Data sheet status            | Change notice   | Supersedes    |
|----------------|-----------------------------------|------------------------------|-----------------|---------------|
| 74AUP1G97 v.8  | 20120815                          | Product data sheet           | -               | 74AUP1G97 v.7 |
| Modifications: | <ul> <li>Package outli</li> </ul> | ne drawing of SOT886 (Figure | e 19) modified. |               |
| 74AUP1G97 v.7  | 20111128                          | Product data sheet           | -               | 74AUP1G97 v.6 |
| 74AUP1G97 v.6  | 20110110                          | Product data sheet           | -               | 74AUP1G97 v.5 |
| 74AUP1G97 v.5  | 20101020                          | Product data sheet           | -               | 74AUP1G97 v.4 |
| 74AUP1G97 v.4  | 20090623                          | Product data sheet           | -               | 74AUP1G97 v.3 |
| 74AUP1G97 v.3  | 20090518                          | Product data sheet           | -               | 74AUP1G97 v.2 |
| 74AUP1G97 v.2  | 20090327                          | Product data sheet           | -               | 74AUP1G97 v.1 |
| 74AUP1G97 v.1  | 20061107                          | Product data sheet           | -               | -             |

#### Low-power configurable multiple function gate

## 18. Legal information

#### 18.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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